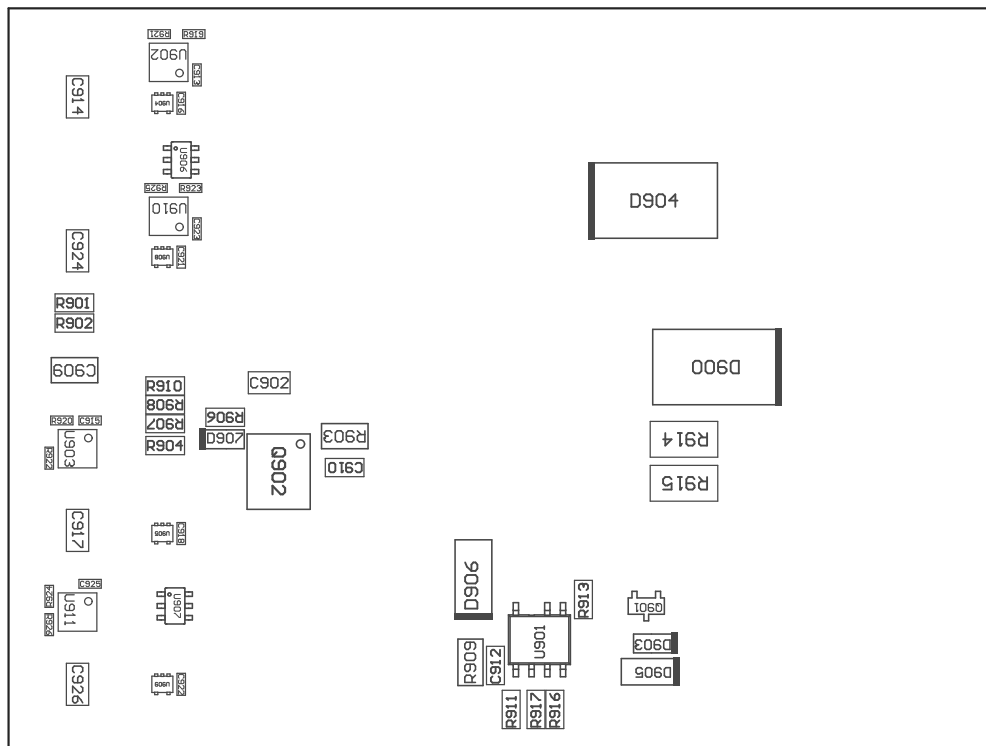


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP10974	REV: A	SVN REV: Not In VersionControl
M2 Board Dimensions			
PLOT NAME = Top Assembly Drawing	GENERATED : 3/16/2015 10:29:07 AM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP10974	REV: A	SUN REV: Not In VersionControl
PLOT NAME = Bottom Assembly Drawing	GENERATED : 3/16/2015	10:29:13 AM	TEXAS INSTRUMENTS

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